

TURN UP THE PERFORMANCE, TURN DOWN THE HEAT.

GORE[®] Thermal Insulation: Enhanced heat spreading for an enhanced user experience.



Together, improving life

GORE[®] Thermal Insulation: Enhanced Thermal Spreading for Mobile Devices

Improve performance, reduce hot spots

The demand for greater performance, functionality, and smaller form factors is increasing, thermal challenges in mobile devices, particularly as many powered components are generating more heat in smaller spaces. More heat generation requires advanced thermal solutions to spread heat more evenly across the device surface and reduce hot spots.

Application areas



Thermal engineers use graphite, heat pipes and vapor chambers to spread and dissipate heat across a larger area to improve device performance. These solutions have a high thermal spreading ratio defined by the thermal conductivity in-plane (k_{xy}) divided by thermal conductivity through-plane (k_z). Despite a high spreading ratio, heat spreaders have relatively high k_z compared to insulators. They are often designed using an air gap with low k_z at the system level to improve the spreading ratio. As heat spreading requirements increase, these thermal solutions can still fail to reduce hot spots due to an insufficient spreading ratio within the available space.

Now, with GORE[®] Thermal Insulation, you can improve the effectiveness of your heat spreading solutions. With a k_z significantly lower than air, enabled by premium aerogel technology, GORE[®] Thermal Insulation will improve the heat spreading ratio and outperform system level air gaps. It can be used independently or in conjunction with heat spreaders to create a higher performing thermal solution. GORE[®] Thermal Insulation can be combined with graphite material



Including GORE[®] Thermal Insulation in thermal designs increases effectiveness of thermal spreading.

GORE[®] Thermal Insulation is a new thermal management solution that increases the designer's ability to direct heat by greater control of z-axis thermal conductivity. More control means superior spreading options that enable components to perform at higher levels for longer, accommodate shrinking form factors, and/or meet surface temperature requirements.



One of many possible configurations

Top View – Hotspot





We can help you beat the heat

Improve your existing solution without compromises



Additional Benefits of using GORE® Thermal Insulation:

Electrically Insulative

- Provides a physical barrier between device components
- Does not create electrical short circuits or EM/RF interference

Ease of Integration

- Can be combined with graphite or heat pipes to optimize performance
- Easy to install with 7 thickness options and ability to customize shape

Development Support

 Gore engineers are available to support with design guidance, modeling and integration from early design cycle through commercialization

GORE[®] Thermal Insulation



1. Pull Tab 2. Protective Film 3. GORE[®] Thermal Insulation 4. Base Adhesive 5. Base Liner

Figure 1: GORE® Thermal Insulation cross section



GORE[®] Thermal Insulation reduces surface "hot spots" and enables enhanced device performance for a better user experience.

Figure 2: GORE[®] Thermal Insulation surface images

TECHNOLOGY EXPERTISE

- High loading of aerogel to obtain low conductivity
- Consistent distribution of aerogel enables consistent conductivity
- Consistent thickness across a range of thicknesses from 100–530 μm

Material data*

CHARACTERISTIC								
Insulation thickness available ^a	0.10 mm	0.12 mm	0.17 mm	0.23 mm	0.28 mm	0.38 mm	0.53 mm	
Adhesive encapsulation width (minimum) ^b	1 mm	1 mm	1 mm	1 mm	1 mm	1 mm	1.5 mm	
Thermal conductivity (k) ^c	0.021 W/m•K			0.020 W/m•K				
Compression @ 100 kPa (14.5 psi)	13%			8%				
Specific heat capacity ^d	1.8 J/g °C							
Bulk density	0.37 g/cc							
Operating temperature ^e	–40 °C to 100 °C							
Protective cover film	Black PET							
Adhesive type	Acrylic							
RoHSf	Meets threshold requirements							
Max part size	100 mm × 200 mm							

^a Nominal thickness based on reported values of thickness of each component of the stack-up.

b Nominal minimum width.

C Nominal conductivity value based on a modified version of ASTM C518.
d Nominal heat capacity measured according to ASTM E2716 Method B at 75 °C.

e Alternate adhesives required to exceed 100 °C.

f To the best of our knowledge, the product listed above does not have any restricted substances above the maximum concentration values listed in RoHS Directive 2011/65/EU and meets the substance restrictions of Article 4 of RoHS Recast including Commission Delegated Directive 2015/863.

*All values based on nominal characteristic and do not represent the specification and tolerance.

By Your Side from Design to Manufacture

Leading OEMs select Gore because our products and services help develop differentiated and innovative products with low development and supply chain risk in a fast-paced, highly competitive market.

GLOBAL MOBILE SUPPLIER

Decades of proven track record as a preferred venting partner of global top OEMs in wide range of applications – from smartphone, smartwatch, earphone, Bluetooth speaker, camera, and tablet to wireless radio.

FAST RESPONSE DESIGNS

The mobile electronics industry develops and releases new products quickly. Gore supports this need for quickness with designs and prototypes to ensure engineering teams can meet their project timelines.

RELIABLE PERFORMANCE

To ensure products are "fit for use", every Gore product must adhere to the highest standards of quality, performance and reliability. Through a comprehensive understanding of enduse applications and requirements, our products do what we say they will do.

SUPPLY SECURITY

Working with the world's largest and most challenging mobile electronic supply chains, we've become experts at supplying high volume, fast ramp products with the timing and quality required for success.

W. L. Gore & Associates

W. L. Gore & Associates is a global materials science company dedicated to transforming industries and improving lives. Since 1958, Gore has solved complex technical challenges in demanding environments — from outer space to the world's highest peaks to the inner workings of the human body. With more than 13,000 Associates and a strong, team-oriented culture, Gore generates annual revenues of \$4.8 billion.

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For additional assistance, please contact a Gore representative.

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